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MULTI-RATE POSITIONER SYSTEM
HAVING AN IMPROVED PROFILING FILTER

Technical Field

This invention relates to an apparatus and a
15 method for positioning a "tool," such as an optical
instrument, a scanner, a laser beam or other radiation
beams, relative to target locations on a workpiece and, in
particular, to a system that accurately coordinates the
positioning of such tools and target locations with a
20 multi-stage positioner in which each stage is optimized
for a particular combination of positioning speed and
positioning distance.

Background of the Invention

A variety of technologies employ tools to sense,
25 micro-machine, or deposit patterns or materials on target
locations on a workpiece. For example, micro-dimensioned
drills may be used to form a cradle for a micro-
dimensioned motor; a micro-dimensioned punch may be used
to punch holes in a thin metal plate; a laser may be used
30 to precisely machine or selectively erode metallic,
crystalline, or amorphous specimens; a machine vision
process may use a laser beam or an electron beam to scan
workpieces having micron-sized features; a microscope may
be positioned to inspect target locations on an integrated
35 circuit; and ion beams may be used to selectively implant
charged particles into an integrated circuit. All of the
above-mentioned processes share a common requirement for

accurately and rapidly positioning a pertinent tool to target locations on the workpiece.

Two emerging, but opposing, requirements exist for coordinating the relative motion between tools and workpieces. Namely, feature sizes are decreasing, causing the need for dimensional precision to increase, while at the same time the overall size of workpieces is increasing. Consequently, the accuracy, size, and speed requirements imposed on tool positioners are taxing the limits of existing positioning systems.

Existing positioners are typically characterized by low speed and long movement or high speed and short movement. Low speed and long movement positioners, such as X-Y translation tables, are characterized by high positional accuracy; whereas high-speed, short-movement positioners, such as galvanometer-driven beam deflectors, are characterized by deflection angle nonlinearities.

A solution for long movement, high-speed positioning is described in U.S. Pat. No. 4,532,402 issued July 30, 1985 for METHOD AND APPARATUS FOR POSITIONING A FOCUSED BEAM ON AN INTEGRATED CIRCUIT in which a high-speed, short-movement positioner ("fast positioner"), such as a galvanometer, is combined with a long-movement, low-speed, but high-accuracy positioner ("slow positioner") such as an X-Y translation table. The two positioners are capable of combining short and rapid movement with long and accurate movement to accurately and rapidly position a tool, such as a laser beam, to target locations on a workpiece, such as an integrated circuit. The combined movement of the two positioners entails first moving the slow positioner to a known location near a target location on the workpiece, stopping the slow positioner, moving the fast positioner to the exact target location, stopping the fast positioner, causing the tool to operate on the target

location, and then repeating the process for the next target location.

However, such a positioning method has serious drawbacks. Clearly, all the starting and stopping causes delays that unduly increase the time required for the tool to process the workpiece. A serious drawback is also imposed upon the computer-based machine tool control file or "database" that typically commands the tool to move to a series of predetermined target locations across the workpiece.

This drawback can be illustrated by the laser machining of a workpiece such as, for example, an integrated circuit of a type having a regular pattern of small features requiring trimming by a laser beam. The positioner and laser beam will cooperate efficiently if the slow positioner can accurately move the laser beam from pattern to pattern and the fast positioner can rapidly direct the laser beam to all of the small features requiring trimming within each pattern.

If, however, the size of the largest pattern exceeds the movement range of the fast positioner, the database positioning the tool across the workpiece must be "panelized" into abutting segments that each fit within the movement range of the fast positioner. The above-described trend toward increased dimensional precision and larger workpieces virtually guarantees the need for panelized databases. Panelization allocates the conflicting tasks of short, high-speed positioning and long, high-accuracy positioning into appropriate movement assignments for the fast and slow positioners.

For example, Fig. 1 shows a portion of an integrated circuit 10 having a substantially regular pattern of transistors and associated electrical interconnections that are amenable to processing with an

ion implantation tool positioned by a panelized database. In this example, the threshold voltages of selected transistors are adjusted by controllably implanting boron ions into appropriate p-channel substrate regions of integrated circuit 10. The substrate areas to be doped cover a larger area than the movement range of the fast positioner. Therefore, the slow positioner drives the ion implantation tool into relative alignment with integrated circuit 10 at an origin 12 of a panel 14 (panels shown in dashed lines) after which movement the fast positioner executes the relatively short movements required between the ion implantation tool and integrated circuit 10 to process the substrate areas within panel 14 commanded by the database. After panel 14 is processed, the slow positioner moves the ion implantation tool into relative alignment with integrated circuit 10 at an origin 16 of a panel 18 after which movement the fast positioner executes the relatively short movements required between the ion implantation tool and integrated circuit 10 to process the substrate areas within panel 18 as commanded by the database.

The above described process is repeated by stepping through origins 20, 24, 28, 32, and 36 of respective panels 22, 26, 30, 34, and 38 until integrated circuit 10 has been completely processed. Note that an interconnect pad 40 is not completely enclosed within a single panel. Fortunately in this instance, interconnect pad 40 requires no ion implantation processing and can be ignored for panelization purposes.

Database panelization is at best an inefficient, approximate optimization that divides the tool path into several predetermined compartmentalized small movement command clusters that are inherently inefficient because the movements are executed incrementally.

Panelization also depends on the movement capacities of the particular positioners employed and the type of tool being positioned. For example, the panels assigned to integrated circuit 10 must be delineated in the database not only according to the pattern regularity of integrated circuit 10, but also according to the movement range of the fast positioner and specific target locations assigned to the ion implantation tool. If the tool type is changed, a different positioner type may be required that processes different features at different target locations. Either change would probably require that the database be repanelized to accommodate the new positioner and tool.

Panelization further requires that each panel within a database must abut adjacent panels within the workpiece without causing a tool operation to straddle or overlap a panel boundary. In the example of integrated circuit 10, if instead of an ion implantation tool a laser beam tool was employed to process metalization of interconnect pad 40, the panelization shown in Fig. 1 may not be suitable because interconnect pad 40 straddles two panels. The same problem can occur if the workpiece includes irregular patterns, such as target locations for holes in an etched circuit board. Some workpiece and tool type combinations are simply not conducive to panelization. And, of course, pattern regularity may repeat, albeit at a dimensional distance greater than the movement range of a particular fast positioner. Adapting a fast positioner having a sufficiently large movement range may be counter-productive because of added mass and nonlinearities.

What is needed, therefore, is an improved apparatus and method for accurately and rapidly positioning a wide variety of tools relative to a wide

variety of workpieces without requiring an unduly massive fast positioner or a panelized tool path database.

Summary of the Invention

5 An object of this invention is, therefore, to provide an improved apparatus and method for automatically and optimally allocating database positioning commands among multiple positioners in a tool path processing system.

10 An advantage of this invention is that it provides an apparatus and a method for performing tool path operations on an arbitrarily large workpiece without requiring a panelized database.

15 Another advantage of this invention is that it provides an apparatus and a method for improving the throughput of tool path operations employing a positioning system.

20 A further advantage of this invention is that it provides an apparatus and a method for reducing the movement range and mass of a fast positioner employed in a positioning system.

25 A multi-rate positioner system of this invention receives unpanelized positioning commands from a database, profiles the commands into half-sine positioning signals, and further processes the half-sine positioning signals into low-frequency and high-frequency positioning signals for actuating the respective slow and fast positioners to target locations specified by the database. The slow and fast positioners move without necessarily stopping in response to a stream of positioning command data while
30 coordinating their individually moving positions to produce temporarily stationary tool positions over target locations defined by the database. The multi-rate positioning system reduces the fast positioner movement range requirement while providing significantly increased

tool processing throughput without requiring a panelized database.

In a first embodiment, an imperfect low-pass filter receives the half-sine positioning signal and substantially divides it into fast and slow positioning signals. An imperfect filter is employed to improve filter response time. Slow positioner errors caused by the nonresponse of the slow positioner to a high frequency feedthrough signal are corrected by directing these feedthrough-related errors to the fast positioner as part of the fast positioner command. Positioning errors caused by inertia and friction associated with the positioners are corrected by comparing the actual tool position with a commanded tool position in feedback networks that modify the slow and fast stage positioning signals.

In a second embodiment, the half-sine positioning signal is divided into its acceleration and position components. Tool processing throughput is further improved by passing the position component through a fourth-order profiling filter that has a fixed delay and produces low-frequency position and acceleration components for driving the slow positioner. The unfiltered position and acceleration components are delayed by the same amount as the fixed delay to produce high-frequency position and acceleration components for driving the fast positioner. Slow positioner errors caused by nonresponsiveness of the slow positioner to fast stage components fed through the profiling filter are corrected by directing these feedthrough-related errors to the fast positioner as part of the fast positioner command. Positioning errors caused by inertia and friction associated with the positioners are corrected by comparing the actual tool position with a commanded tool position in feedback networks that modify the slow and

fast stage positioning signals.

Additional objects and advantages of this invention will be apparent from the following detailed description of preferred embodiments thereof, which
5 proceed with reference to the accompanying drawings.

Brief Description of the Drawings

Fig. 1 is a pictorial plan view of an integrated circuit work field panelized for tool processing according to a prior art positioner movement panelization scheme.

10 Fig. 2 is a pictorial block diagram of a first embodiment of a multi-stage laser beam positioning system of this invention.

Figs. 3A and 3B are time versus velocity graphs showing respective two- and three-segment positioner
15 velocity profiles processed from positioning commands according to this invention.

Fig. 4 is a fragmentary pictorial side view showing a prior art galvanometer-driven mirror positioner of a type suitable for use with this invention.

20 Fig. 5 is a waveform graph representing fast and slow positioner stage velocities and positions responsive to positioning signals according to this invention.

Fig. 6 is a waveform graph representing the time and movement parameters required to position the fast and
25 slow stages for laser drilling 16 holes according to the first embodiment of this invention.

Fig. 7 is a pictorial block diagram of a second embodiment of a multi-stage laser beam positioning system of this invention.

30 Figs. 8A to 8E are waveform graphs representing the acceleration and position versus time required to position the fast and slow stages along a generally triangular stair-stepped movement profile with the second embodiment of this invention.

Fig. 9 is a waveform graph representing the time and movement parameters required to position the fast and slow stages for laser drilling 16 holes according to the second embodiment of this invention.

5 Detailed Description of Preferred Embodiments

Fig. 2 shows a multi-stage tool positioner system 50 having positioning command execution capabilities in accordance with this invention. Positioner system 50 is described only by way of example with reference to a laser-based hole cutting system that
10 employs a digital signal processor ("DSP") 52 to control a fast galvanometer positioner stage 54 ("fast stage 54"), a slow X-axis translation stage 56 ("slow stage 56"), and a slow Y-axis translation stage 58 ("slow stage 58") to
15 direct a laser beam 60 to target locations on a workpiece 62, such as an etched circuit board. Although positioner system 50 is configured with fast stage 54 mounted on slow stage 56 and workpiece 62 mounted on slow stage 58, other configurations of tool positioning systems, such as one in
20 which fast stage 54 is mounted in a fixed position and workpiece 62 is mounted on slow stages 56 and 58, may advantageously employ this invention.

A system control computer 63 processes a tool path database stored in a database storage subsystem 64.
25 The database contains the desired processing parameters for cutting holes and/or profiles with laser beam 60 in workpiece 62. The database is conventionally compiled using a tool path generating program, such as SMARTCAM[™] manufactured by Point Control Software located in Eugene,
30 Oregon. System control computer 63 conveys parsed portions of the stored database to a laser controller 68 and position control portions of the database as a data stream to a delta process 70. Delta process 70 resolves the data stream into delta position ("dx" and "dy"), delta

velocity ("dv"), and delta time ("dt") components for each intended change in the path of laser beam 60 across workpiece 62. Consequently, each movement of laser beam 60 is defined in dx, dy, dv, and dt components that are further processed by a position profiler 72 into a half-sine profiled positioning signal.

Laser controller 68 is controlled by timing data generated by delta process 70 and further coordinated by a triggering process that synchronizes the firing of a laser 76 to the motion of fast stage 54 and slow stages 56 and 58 according to a synchronization technique, such as one described in U.S. Pat. No. 5,453,594, issued September 26, 1995, for RADIATION BEAM POSITION AND EMISSION COORDINATION SYSTEM, which is assigned to the assignee of this application.

Delta process 70 generates the dx, dy, dv, and dt components in accordance with a preferred BASIC language signal processing procedure described below with reference to Figs. 3A and 3B.

Before calling the preferred procedure, referred to as "gen_move," limiting values for Maximum Acceleration (amax), Maximum Velocity (vmax), and Minimum Time (tmin) are initialized. The limiting values are physical hardware limits imposed by the particular positioner hardware (fast or slow) that is required to move a majority of the distance in response to a particular positioning command. For example, if the movement distance is less than 25 percent of the maximum fast positioner movement range, then the values are set for the fast positioner. Otherwise the values are set for the slow positioner. Limiting values for fast stage 54 and slow stages 56 and 58 are:

		Fast	Slow
35	vmax (Meters/Second)	1	0.25
	amax (g)	50	1.0

tmin (Milliseconds) 2 20.0

Procedure gen_move calculates the dx, dy, dv, and dt values required for a positioner stage to move in either two or three movement segments from any initial position and initial velocity to any final position and final velocity.

All movement segments include some combination of a half-sine profiled acceleration segment ("segment 1"), a constant velocity segment ("segment 2"), and a half-sine profiled deceleration segment ("segment 3"). As shown in Fig. 3A, when a positioning command is sufficiently large to cause the positioner velocity to reach either +vmax or -vmax, segment 2 is included between segments 1 and 3. Otherwise, as shown in Fig. 3B, a two segment movement command is executed that includes only segments 1 and 3 (segment 2=0). Procedure gen_move generally conforms to, and skilled workers will readily understand, the following BASIC language description.

PROCEDURE gen_move (g&,h&):

REMARK "g" and "h" are pointers into an indexed array of positions and velocities extracted from the database.

xi=px(g&) !initial x position !um
 yi=py(g&) !initial y position
 xvi=vx(g&) !initial x velocity !um/sec
 yvi=vy(g&) !initial y velocity

xf=px(h&) !final x position
 yf=py(h&) !final y position
 xvf=vx(h&+1) !final x velocity
 yvf=vy(h&+1) !final y velocity

REMARK Calculate the maximum (or minimum) absolute velocity for X and Y movement based on the total change in position, initial and final velocities, and the minimum movement time (limited to vmax).

dx=xf-xi
 dy=yf-yi

xvmax=dx/tmin-(xvi+xvf)/2
 IF xvmax>vmax

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        xvmax=vmax
    ENDIF
    IF xvmax<-vmax
        xvmax=-vmax
5    ENDIF

    REMARK    Assumes that dt1 = dt3.  If dt1 and dt3 = tmin,
    maximum velocity is employed.

10    yvmax=dy/tmin-(yvi+yvf)/2
    IF yvmax>vmax
        yvmax=vmax
    ENDIF
    IF yvmax<-vmax
15    yvmax=-vmax
    ENDIF

    REMARK    Calculate dt for segments 1 and 3, assuming
    three segments are required to execute this particular
20    positioning command.

    kpo2=(PI/2)/amax
    dt1=MAX(tmin,ABS((xvmax-xvi)*kpo2),ABS((yvmax-yvi)*kpo2))
    dt3=MAX(tmin,ABS((xvf-xvmax)*kpo2),ABS((yvf-yvmax)*kpo2))
25

    REMARK    Calculate dt2 for both the x and y axis (xdt2
    and ydt2).  If either result is positive, a constant
    velocity segment 2 is required.  xdt2 and ydt2 also
    determine a dominant axis, i.e., the axis that requires
30    the most time to move at constant maximum velocity.

    IF xvmax>0
        xdt2=(dx-((xvi+vmax)*dt1/2)-((xvf+vmax)*dt3/2))/vmax
    ELSE
35    xdt2=(dx-((xvi-vmax)*dt1/2)-((xvf-vmax)*dt3/2))/-vmax
    ENDIF
    IF yvmax>0
        ydt2=(dy-((yvi+vmax)*dt1/2)-((yvf+vmax)*dt3/2))/vmax
    ELSE
40    ydt2=(dy-((yvi-vmax)*dt1/2)-((yvf-vmax)*dt3/2))/-vmax
    ENDIF

    IF xdt2>0 OR ydt2>0    !three segment movement
    REMARK    Calculate dp,dv for each movement segment
45    IF xdt2>ydt2    !X axis Primary
        dx1=(xvi+xvmax)*dt1/2
        xdv1=xvmax-xvi
        dx2=((-xvi-xvmax)*dt1/2)+((-xvmax-xvf)*dt3/2)+dx
        xdv2=0
50    dx3=(xvmax+xvf)*dt3/2
        xdv3=xvf-xvmax

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      ydt2=xdt2
      kb=1/(2*ydt2+dt3+dt1)
      dy1=((yvi-yvf)*((dt1*dt3)/2+(dy+yvi*ydt2)*dt1)*kb
      ydv1=((-yvi-yvf)*dt3+2*dy-2*yvi*(ydt2+dt1))*kb
5      dy2=(2*dy-dt1*yvi-dt2*yvf)*ydt2*kb
      ydv2=0
      dy3=((yvf-yvi)*((dt3*dt1)/2+(dy+ydt2*yvf)*dt3)*kb
      ydv3=((yvi+yvf)*dt1-2*dy+2*(dt3+ydt2)*yvf)*kb
10     ELSE !Y primary axis
      dy1=(yvi+yvmax)*dt1/2
      ydv1=yvmax-xvi
      dy2=((-yvi-yvmax)*dt1/2)+((-yvmax-yvf)*dt3/2)+dy
      ydv2=0
      dy3=(yvmax+yvf)*dt3/2
15     ydv3=yvf-yvmax
      xdt2=ydt2
      kb=1/(2*xdt2+dt3+dt1)
      dx1=((xvi-xvf)*((dt1*dt3)/2+(dx+xvi*xdt2)*dt1)*kb
      xdv1=((-xvi-xvf)*dt3+2*dx-2*xvi*(xdt2+dt1))*kb
20     dx2=(2*dx-dt1*xvi-dt3*xvf)*xdt2*kb
      xdv2=0
      dx3=((xvf-xvi)*((dt3*dt1)/2+(dx+xdt2*xvf)*dt3)*kb
      xdv3=((xvi+xvf)*dt1-2*dx+2*(dt3+xdt2)*xvf)*kb
      ENDIF
25     ELSE !two segment movement
      REMARK Calculate dtx and dty to determine dt for
      segments 1 and 3.
      twomovetime (xvi,xvf,xi,xf,xdt)
      twomovetime (yvi,yvf,yi,yf,ydt)
30
      REMARK For two segment movement, dt1 = dt3 = the larger
      of dtx or dty.

      dt1=MAX(xdt,ydt)
35     dt3=dt1

      REMARK Calculate dp and dv for segments 1 and 3.
      twosegmentmove
      xdt2=0
40     ydt2=0
      dx2=0
      dy2=0
      xdv2=0
      ydv2=0
45     ENDIF

      RETURN

      REMARK End of procedure gen_move
50
      PROCEDURE twosegmentmove

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dx1=dx/2+xvi*dt1/4-xvf*dt1/4
xdv1=dx/dt1-3*xvi/2-xvf/2

dy1=dy/2+yvi*dt1/4-yvf*dt1/4
5 ydv1=dy/dt1-3*yvi/2-yvf/2

dx3=dx/2-xvi*dt3/4+xvf*dt3/4
xdv3=-dx/dt3+xvi/2+3*xvf/2

10 dy3=dy/2-yvi*dt3/4+yvf*dt3/4
ydv3=-dy/dt3+yvi/2+3*yvf/2

RETURN

15 PROCEDURE twomovetime(vi,vf,ip,fp,VAR dt)
LOCAL k1,k2,k3
dt=tmin
k1=3*vi+vf
kls=k1^2
20 k2=(32/PI)*amax*(fp-ip)
k3=PI/(8*amax)
IF kls+k2>0
dt=MAX(dt,k3*(-k1+SQR(kls-k2)))
ENDIF
25 IF kls-k2>0
dt=MAX(dt,k3*(k1+SQR(kls-k2)))
ENDIF
k1=vi+3*vf
kls=k1^2
30 IF kls+k2>0
dt=MAX(dt,k3*(-k1+SQR(kls+k2)))
ENDIF
IF kls-k2>0
dt=MAX(dt,k3*(k1+SQR(kls-k2)))
35 ENDIF
RETURN

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Referring again to Fig. 2, the dx, dy, dv, and dt components generated by delta process 70 are further processed by position profiler 72 into the half-sine positioning signal required to cause fast stage 54 and slow stages 56 and 58 to move as commanded by the database. Ideally, positioner acceleration is proportional to motive force, and motive force is proportional to electrical current supplied to a positioner driver such as a linear or rotary servo motor or a galvanometer coil. Therefore, the positioning signal

produced by position profiler 72 is a series of "full-spectrum" half-sine profiled acceleration-inducing positioning steps that cause movements such as those shown in Figs. 3A and 3B. The full-spectrum bandwidth need only
5 be about 250 Hertz, a bandwidth sufficient to drive galvanometer-driven mirror positioner 100 at its maximum frequency.

Instantaneous values of the full-spectrum positioning signal are generated by DSP 52 at a rate of
10 about 10,000 points per second by employing the dx, dy, dv, and dt components generated by delta process 70 as variables for a sine value generation program running in DSP 52. Alternatively, the dx, dy, dv, and dt components may be employed to address and fetch associated sinusoidal
15 waveform values stored in a sine value lookup table that is incorporated within DSP 52.

In a first embodiment, the resulting full-spectrum positioning signal is received by a low-pass filter 78 that passes a low-frequency position ("LFP")
20 signal portion to an adder 80. Adder 80 functions as a high-pass filter by subtracting the LFP signal portion from the full-spectrum positioning signal to form a high-frequency position ("HFP") signal portion. The HFP and LFP signal portions together substantially equal the full-spectrum positioning signal generated by position profiler
25 72. Consequently, the HFP and LFP signals are processed and distributed, respectively, to fast stage 54 and slow stages 56 and 58, each of which is optimized to respond in substantially real time to the respectively applied
30 position signal frequencies.

In particular, the HFP signal is processed through adders 82 and 84 and a feed forward process 86 to a galvanometer driver 88. Likewise, the LFP signal is processed through adders 90 and 92 and a feed forward

process 94 to a linear servo motor driver 96.

Galvanometer driver 88 provides deflection control current to a pair of mirror deflecting galvanometers in fast stage 54, and servo motor driver 96 provides control current to linear servo motors that control the positioning of slow stages 56 and 58.

Fig. 4 shows a prior art galvanometer-driven mirror positioner 100 of a type suitable for use as fast stage 54. Galvanometer driver 88 (Fig. 2) provides rotational control current on conductors 102 to respective X-axis and Y-axis high-speed response D.C. motors 104 and 106 that rotate shafts 107 in bearings 108 to selectively pivot a pair of mirrors 110 and 112 that deflect laser beam 60 through an optional lens 114 to a predetermined target location on workpiece 62.

Alternatively, a nonbearing motion positioner, such as a piezoelectric element, a voice coil actuator, or other limited angle high-speed positioner device could be used in place of galvanometer-driven mirror positioner 100 in positioner system 50.

Likewise with reference to Fig. 2, alternative accurate rotary or linear positioner mechanisms may be substituted for the linear servo motors driving slow stages 56 and 58. However, in positioner system 50, ANORAD motors that preferentially respond to the LFP signal are preferred.

In the first embodiment, low-pass filter 78 has a 25 Hertz three-decibel rolloff frequency, has a 100 decibel per decade slope, and is implemented as a fifth-order (five stage) digital filter that compromises filtering effectiveness for fast response. Consequently, some high-frequency signals generated by position profiler 72 feed through low-pass filter 78 into the LFP signal portion causing the HFP signal portion conveyed from adder

80 to adder 82 to be missing some high-frequency components of the full-spectrum positioning signal. Nevertheless, accurate positioning requires that the entire positioning signal spectrum be processed.

5 Therefore, because the LFP signal portion contains residual high frequencies to which fast stage 54 should respond but to which slow stages 56 and 58 cannot respond, the signal generated by adder 90 is also conveyed to adder 82 to cause fast stage 54 to respond to the residual high
10 frequencies present in the LFP signal portion.

Moreover, two signals are added to each of the HFP and LFP signal portions to reduce positional errors between the commanded position and the actual position of laser beam 60 on workpiece 62. The HFP and LFP signal
15 portions represent the ideal signal values required to cause the commanded positioning of stages 54, 56, and 58. However, practical factors such as gravity, friction, mass, and inaccuracies in the full-spectrum positioning signal generated by position profiler 72 are not
20 contemplated in the unmodified HFP and LFP signal portions.

The practical factors are accounted for by sensing the actual positions of stages 54, 56, and 58 with position sensors 120 and 122 to provide predictive
25 position feedback data to DSP 52. Position sensors 120 and 122 may be well-known types employing rotating capacitor plates, linear and rotary encoder scales, or interferometer motion detectors together with appropriate analog-to-digital and/or digital-to-analog conversion
30 techniques.

As laser beam 60 undergoes movement across workpiece 62, the sensed beam position is continuously compared to the commanded beam position, with the positional difference representing a degree to which the

practical factors have caused positioning errors. In particular, sensed position data of fast stage 54 are generated by position sensor 120 and subtracted from the commanded position at adder 82 to generate positional difference data that are combined in adder 84 with a next subsequent HFP signal portion conveyed by feed forward process 86. Likewise, sensed position data of slow stages 56 and 58 are generated by position sensor 122 and subtracted from the commanded position at adder 90 to generate positional difference data that are combined in adder 92 with a next subsequent HFP signal portion conveyed by feed forward process 94.

Fig. 5 graphically shows how fast stage 54 and slow stages 56 and 58 coordinate their movements in response to a representative full-spectrum positioning signal 128 (shown in bold lines), which is divided in DSP 52 (Fig. 2) into an HFP signal portion 130, and an LFP signal portion 132. HFP signal portion 130 represents the AC-coupled, 25-250 Hertz high-passband portion of full-spectrum positioning signal 128, and LFP signal portion 132 represents the direct-coupled, 0-25 Hertz low-passband portion of full-spectrum positioning signal 130.

Each half-sine profiled positioning step in full-spectrum positioning signal 128 (uniquely identified by a letter suffix, e.g., 128A, 128B, 128C, and 128D) causes a correspondingly identified step in HFP signal portion 130 (e.g., 130A, 130B, 130C, and 130D). In this example, each positioning step is separated from adjacent positioning steps by about 10 milliseconds, but the time separation, if any, is a function of timing data in the tool path database.

Fig. 5 further shows a resultant fast stage velocity waveform 134 and a resultant slow stage velocity waveform 136 that show, respectively, how fast stage 54

and slow stages 56 and 58 respond to HFP signal portion 130 and LFP signal portion 132.

5 In particular, HFP signal portions 130A, 130B, 130C, and 130D each include acceleration segments that cause fast stage 54 to undergo sine-profiled velocity changes as represented by corresponding fast velocity waveform pulses 134A, 134B, 134C, and 134D. Fast velocity waveform 134 has a baseline 138 that transitions in a negative velocity direction and settles at a value of
10 about -100 millimeters per second. This baseline shift is caused by the combined signal processing effects of adders 80, 82, and 90 that couple a portion of LFP signal portion 132 into the HFP signal portion processing circuits.

15 HFP signal portion 130 also represents how fast stage 54 responds positionally to each of fast velocity pulses 134. The peak fast stage positioning displacement required in this example is about 2.8 millimeters, which is well within the 10 millimeter linear range of a low-mass, galvanometer-driven mirror positioner.

20 LFP signal portion 132 also represents how slow stages 56 and 58 respond positionally to slow velocity waveform 136. Slow stage velocity waveform 136 transitions in a positive velocity direction and settles at a value of about +100 millimeters per second. In this
25 example, the slow stage position changes linearly with time such that at least one of slow stages 56 and 58 do not stop moving.

30 Full-spectrum positioning signal 128 also represents the net positions resulting from the combined fast and slow stage positions represented respectively by waveforms 132 and 130. Plateaus 140A, 140B, 140C, and 140D indicate 10 millisecond time periods during which the coordinated position is stationary even though stages 54, 56, and 58 may all be moving. This is clearly shown for

plateau 140C, directly under which waveforms 130 and 132 intersect with substantially equal and opposite slopes. Plateaus 140 correspond to time periods during which laser 76 may be triggered to cut holes in workpiece 62.

5 With reference to Figs. 2 and 6, tool processing throughput of the first embodiment of multi-stage tool positioner system 50 was evaluated by computer modeling a wide variety of movement profiles and sequences. It was learned that as the move lengths increased beyond about 3
10 millimeters and the laser hole drilling times decreased below about 5 milliseconds, the 1 g acceleration limit of slow stages 56 and 58 was exceeded. In particular, a sequence of moves and drills in one direction immediately followed by a sequence of moves and drills in the opposite
15 direction would exceed the 1 g acceleration limit when the movement direction reversed.

 A proposed solution to this limitation entailed reducing the cutoff frequency of low-pass filter 78 to reduce the acceleration of slow stage 58 and adding a
20 feedback loop from the output of adder 80 to position profiler 72. Fig. 6 shows for the proposed solution the resulting timing and positioning movements of fast stage 54 and slow stages 56 and 58 required for laser 76 to drill 16 holes in workpiece 62. Motion of slow stages 56
25 and 58 is represented by a servo acceleration waveform 150 and a servo velocity waveform 152. Servo acceleration waveform 150 shows a peak acceleration 154 of about 1 g, which is within the required acceleration limit, and servo velocity waveform 152 shows a peak velocity 156 of about
30 175 millimeters per second, which is well within the 250 millimeter per second limit.

 Fast stage 54 motion is represented by a galvo position waveform 158 that includes repositioning movements 160 and position coordinating movements 162. 50

millisecond pulses of laser 76 are represented by laser waveforms 164.

Optimal throughput of tool path operations typically require pulsing laser 76 during the position coordinating movement 162 that immediately follows each repositioning movement 160. Unfortunately, the proposed solution required delaying the start of each repositioning movement 160 until fast stage 54 was far enough from its 10 millimeter travel limit to ensure that the next repositioning movement 160 could be made without exceeding the 10 millimeter travel limit. Therefore, while the proposed solution did control the acceleration, it significantly limited throughput for sequences of long moves greater than about three millimeters. Fig. 6 shows that the proposed solution required 550 milliseconds to drill 16 holes with laser 76.

Fig. 7 shows a second embodiment of DSP 52 in which tool processing throughput was improved by replacing low-pass filter 78 (Fig. 2) with a profiling filter 170 having a constant delay and adding a delay element 172 between position profiler 72 and adders 80 and 82 to compensate for the constant delay of profiling filter 10. Delay element 172 also delays, and thereby, synchronizes the laser triggering pulses generated by position profiler 72 and directed to laser controller 68. Profiling filter 170 and delay element 172 cooperate to move slow stages 56 and 58 smoothly over the average position profile while limiting its acceleration to ± 1 g and cooperate to limit fast stage 54 positioning movements to ± 10 millimeters.

The half-sine positioning signal generated by position profiler 72 includes a position component and an acceleration component. The position component is received by profiling filter 170 to produce filtered position command data for driving slow stages 56 and 58.

Profiling filter 170 is preferably a fourth-order low-pass filter represented below by Eq. 1.

$$G(s) = \left[\frac{1}{\frac{s^2}{\omega^2} + \frac{2\zeta s}{\omega} + 1} \right]^2 \quad (1)$$

In Eq. 1, ω is the natural, or cutoff, frequency of profiling filter 170 and ζ is its damping ratio. Preferably, ω equals 38 radians per second and ζ equals 0.707. The 0.707 value of ζ is referred to as the critical damping ratio because it produces a phase lag that is linear with frequency up to a natural frequency ω_n of profiling filter 170. The linear phase lag results in a constant time delay for any half-sine positioning signal having a frequency content up to the natural frequency. For the Eq. 1 filter, the time delay equals $4\zeta/\omega$ seconds.

Because profiling filter 170 produces filtered position command data having a constant time delay with respect to the half-sine positioning signal position component, the constant time delay is compensated for by delay element 172. Delay element 172 is preferably implemented by DSP 52 as a programmed delay in conveying the half-sine positioning signal acceleration and position components from position profiler 72 to adders 80 and 82. Thereby, half-sine positioning signals directed to fast stage 54 are time synchronized with the filtered position commands directed to slow stages 56 and 58.

The acceleration command from position profiler 72 is also filtered by profiling filter 170 to provide a servo acceleration feed forward signal to adder 80 and feed forward process 94. In a manner similar to the first embodiment, adder 80 functions as a high-pass filter by subtracting the servo acceleration feed forward signal

from the acceleration component of the full-spectrum positioning signal to form a galvo acceleration feed forward signal, which is conveyed to feed forward process 86. Likewise, the filtered position command from
5 profiling filter 170 and the delayed position component of the half-sine positioning signal are conveyed respectively to adders 90 and 82 for processing and distribution, respectively, to slow stages 56 and 58 and fast stage 54. A galvo filter 174 and a servo filter 176 are conventional
10 loop compensation filters that function to keep fast stage 54 and slow stages 56 and 58 stable.

The ± 1 g acceleration capability of slow stages 56 and 58 and the ± 10 millimeter travel limit of fast stage 54 constrain the parameters of the half-sine
15 positioning signal generated by position profiler 72 and the cutoff frequency of profiling filter 170. These constraints are described with reference to Figs. 8A to 8E, which show exemplary waveforms in response to a triangular move profile 180 shown in Fig. 8A. Triangular
20 move profile 180 includes a series of upwardly moving positioning steps 182 followed by a series of downwardly moving positioning steps 184. Slow stages 56 and 58 respond as shown in Fig. 8B in which a slow stage acceleration waveform 186 represents slow stages 56 and 58
25 undergoing acceleration impulses 188, 190, and 192 at the beginning, middle, and end, respectively, of triangular move profile 180. Multiple high-frequency acceleration impulses occur at each of positioning steps 182 and 184 but are filtered out by profiling filter 170 leaving slow
30 stage acceleration waveform 186.

As the cutoff frequency of profiling filter 170 is decreased (heavier filtering), the maximum amplitude of acceleration impulses 188, 190, and 192 decreases. Therefore, for a particular slow stage acceleration limit

(e.g., 1 g), the cutoff frequency can be set using this constraint.

However, another constraint sets a lower bound on the cutoff frequency. Because of profiling filter 170, the actual position profile of slow stages 56 and 58 does not exactly follow the waveform of triangular move profile 180, but is more "rounded." As shown in Fig. 8C, this causes the positioning of fast stage 54 (i.e., the difference between triangular move profile 180 and the move profile of slow stages 56 and 58) to move as represented by a fast stage positioning waveform 194. Examining Figs. 8B and 8C reveals that the position of fast stage 54 reaches maxima 196, 198, and 200 at times corresponding to acceleration impulses 188, 190, and 192 of slow stage acceleration waveform 186. Unfortunately, decreasing the cutoff frequency of profiling filter 170 acts to increase the maximum movement of fast stage 54. Therefore, a compromise must be reached between limiting slow stage acceleration and fast stage positioning.

Another variable that can be used to reach this compromise is the shape of the desired move profile. By varying the maximum velocity, acceleration, and/or on time of laser 76 for the individual steps in the desired move profile, the magnitude of acceleration impulses 188, 190, and 192 can be controlled. Lowering the acceleration impulse magnitude allows the cutoff frequency of profiling filter 170 to be increased, which in turn decreases the maximum movement of fast stage 54.

Move profile acceleration and/or laser on-times may also be set as a function of movement distance. A further improvement in throughput is possible by predicting the maximum slow stage acceleration as a function of prior positioning steps and tailoring the acceleration or laser on-time of the next step to place a

bound on the predicted acceleration.

Profiling filter 170 is implemented by cascading two or more second-order filters having critical damping ratios. As the number of cascaded filters increases
 5 beyond two, their cutoff frequencies increase by about the square root of the number of filters (e.g., two filters have cutoffs that are 1.414 times the cutoff for a single filter). Preferably two filters are cascaded to provide good smoothing while keeping the overall filter
 10 implementation simple.

The profiling filter response represented by Eq. 1 can be expressed as a discrete equivalent through a bilinear transformation. The resulting digital transfer function is represented below by Eq. 2.

15

$$G_z(z) = \frac{k(z^2 + 2z + 1)^2}{(z^2 + b_1z + b_2)^2} \quad (2)$$

20

The time-domain equations for filter outputs (y_k) and (w_k), given prior inputs and outputs, are represented below by Eqs. 3 and 4.

$$y_k = w_k + 2w_{k-1} + w_{k-2} - b_1y_{k-1} - b_2y_{k-2} \quad (3)$$

25

$$w_k = k(V_k + 2V_{k-1} + V_{k-2}) - b_1w_{k-1} - b_2w_{k-2} \quad (4)$$

The coefficients in Eqs. 3 and 4 are determined as represented below in Eq. 5.

$$\begin{bmatrix} k \\ b1 \\ b2 \end{bmatrix} = \begin{bmatrix} \frac{\omega^2 T^2}{4+4\zeta T\omega+T^2\omega^2} \\ \frac{-8+2T^2\omega^2}{4+4\zeta T\omega+T^2\omega^2} \\ \frac{-4\zeta T\omega+4+T^2\omega^2}{4+4\zeta T\omega+T^2\omega^2} \end{bmatrix} \quad (5)$$

15 In Eq. 5, T is the sample period of the filter, ω is its cutoff frequency, and ζ is its damping ratio.

For profiling filter 170, the preferred 38 radian per second cutoff frequency (about 6 Hertz) is a very low frequency compared to the 10 kiloHertz rate at which DSP 52 updates positioning data for slow stages 56 and 58. If profiling filter 170 runs at the 10 kiloHertz slow stage update frequency, the discrete filter coefficients become sensitive to roundoff errors because the poles of the discrete filter move close to the unit circle. Therefore, it is preferred that profiling filter 170 run as two second-order filters as represented in Eqs. 3 and 4 to reduce the order of the filter equation and to keep the filter coefficients reasonably controlled. Profiling filter 170 also receives the acceleration command from position profiler 72 and generates the filtered acceleration command that is conveyed to servo feed forward process 94 and to adder 80.

The desired move profile commands are preferably calculated at the 10 kiloHertz updating rate, and the slow stage acceleration and actual (not commanded) position is subtracted therefrom at adders 80 and 82 to produce, respectively, the fast stage acceleration and position command signals.

As shown in Fig. 8C, for a properly implemented profiling filter 170, the fast stage position dithers about 0 (after transients decay) for long moves. If the delay of profiling filter 170 is not matched by delay element 172, the fast stage position will remain above and below zero in response to upwardly moving positioning steps 182 and downwardly moving positioning steps 184, respectively.

Fig. 8D shows the resulting slow stage position, and Fig. 8E shows the combined position resulting from fast and slow stage movements represented in Figs. 8C and 8D. Note that the combined position shown in Fig. 8E lags triangular move profile 180 of Fig. 8A by about 74 milliseconds, which is about the constant delay of profiling filter 170 and delay element 172.

Fig. 9 shows for the second embodiment the resulting timing and positioning movements of fast stage 54 and slow stages 56 and 58 required for laser 76 to drill 16 holes in workpiece 62. Motion of slow stages 56 and 58 is represented by a servo acceleration waveform 210 and a servo velocity waveform 212. Servo acceleration waveform 210 shows a peak acceleration 214 of about 1 g, which is within the required acceleration limit, and servo velocity waveform 212 shows a peak velocity 216 of about 375 millimeters per second.

Fast stage 54 motion is represented by a galvo position waveform 218 that includes repositioning movements 220 and position coordinating movements 222. Fifty millisecond pulses of laser 76 are represented by laser waveforms 224.

As described with reference to Fig. 6, optimal throughput of tool path operations typically require pulsing laser 76 during the position coordinating movement 222 that immediately follows each repositioning movement

220. Fig. 9 shows that the second embodiment requires only 300 milliseconds to drill 16 holes with laser 76. Actually the comparison between Figs. 6 and 9 is even more striking (225 milliseconds versus 550 milliseconds) because in typical applications the up-front delay of about 75 milliseconds to the first hole occurs only once for a sequence of several hundred holes. As a further advantage of the second embodiment, fast stage 54 operates more centered in its range of travel, which improves its positioning accuracy.

The foregoing embodiments carry out signal processing for an unspecified single axis of motion for each of the fast and slow positioner stages. Skilled workers will readily understand how to replicate the signal processing to coordinate the motion of both axes and both stages.

The above-described coordinated positioning is particularly beneficial for applications such as laser beam hole cutting that requires rapid movement between target locations along a tool path combined with pauses at each target location to fire the laser to cut a hole but, of course, is not limited to that application.

This invention provides an improved combination of positioning accuracy, positioning speed, minimized or eliminated stopping time, nonpanelized tool path databases, and minimized fast stage movement range requirements.

Skilled workers will recognize that portions of this invention may be implemented differently from the laser beam micro-machining implementation described above. For example, a wide variety of tools may be moved by the fast positioner stage, such as micro-dimensioned drills, punches, lasers, laser beams, radiation beams, particle beams, beam producing devices, microscopes, lenses,

optical instruments, and cameras. Also, many different positioning devices may be employed in different combinations drawn from among galvanometers, voice coils, piezoelectric transducers, stepper motors, and lead screw positioners. The DSPs need not be completely digital and may, for example, include any suitable combination of analog and digital subcircuits. Of course, the positioning signal profiles, spectral bandwidth and amplitudes, and filter characteristics described herein may all be modified to suit the requirements of other positioning applications.

It will be obvious to skilled workers that many changes may be made to the details of the above-described embodiments of this invention without departing from the underlying principles thereof. The scope of the present invention should, therefore, be determined only by the following claims.

Claims

1. An apparatus for positioning a tool relative to a set of target locations on a workpiece in response to a set of unpanelized positioning commands received from a database, comprising:

5 a first positioner stage effecting a controlled first range of relative movement between the tool and the workpiece at a first positioning acceleration;

10 a second positioner stage effecting a controlled second range of relative movement between the tool and the workpiece at a second positioning acceleration, the second range of relative movement being greater than the first range of relative movement, and the second positioning acceleration being less than the first positioning acceleration;

15 a signal processor deriving from the set of unpanelized positioning commands a movement-controlling signal;

20 a filter having an amount of delay and splitting the movement-controlling signal into first and second frequency portions, the second frequency portion lagging the first frequency portion by the amount of delay;

25 a delay element delaying the first frequency portion by substantially the amount of delay to provide a delayed first frequency portion that is substantially synchronized with the second frequency portion;

30 a first positioner driver controlling the first range of relative movement of the first positioner stage in response to the delayed first frequency portion; and

a second positioner driver controlling the second range of relative movement of the second positioner stage in response to the second frequency portion.

2. The apparatus of claim 1 in which the tool is at least one of a drill, a punch, a laser, a laser



beam, an ion beam, a radiation beam, a microscope, a lens, an optical scanner, and a camera.

3. The apparatus of claim 1 in which each of the first and second positioner stages is moved by at least one of a galvanometer, a voice coil, a piezoelectric transducer, a stepper motor, a rotary servo motor, a linear servo motor, and a lead screw.

4. The apparatus of claim 1 in which at least one of the first and second positioner stages is capable of positioning the tool along two orthogonal axes.

5. The apparatus of claim 1 in which the second positioner stage includes an X-axis translation stage and a Y-axis translation stage and the first positioner stage is mounted on the X-axis translation stage.

6. The apparatus of claim 5 in which the workpiece is mounted on the Y-axis translation stage.

7. The apparatus of claim 1 in which the first and second positioner stages coordinate the first and second positioning velocities such that the tool is rendered temporarily stationary relative to the workpiece while the first and second positioner stages are moving.

8. The apparatus of claim 1 in which the delay element is implemented as a programmed delay that is executed by the signal processor.

9. The apparatus of claim 1 in which the filter employs a fourth-order low-pass filtering function to generate a position component of the second frequency portion.

10. The apparatus of claim 1 further including a fourth-order low-pass filter function to generate from an acceleration component of the first frequency portion an acceleration component of the second frequency portion.

11. The apparatus of claim 1 in which the second frequency portion is subtracted from the delayed



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first frequency portion to generate a high-frequency positioning signal portion that drives the first positioner driver.

- 5 12. A method for positioning a tool relative to a set of target locations on a workpiece, comprising:
 providing from a database unpanelized positioning commands that define the set of target locations to which a tool is to be directed;
 filtering the positioning commands to generate a
10 delayed slow positioning signal;
 delaying the positioning commands to generate delayed positioning commands;
 processing the delayed slow positioning signal and the delayed slow positioning commands to generate a
15 fast positioning signal; and
 applying the delayed slow and fast positioning signals to respective slow and fast positioners, the slow and fast positioners responding to the positioning signals by at least partly uninterrupted concurrent motion in a
20 coordinated fashion to produce temporarily stationary tool positions over the target locations.

13. The method of claim 12 in which the applying step further entails moving the tool along a pair of orthogonal axes.

- 25 14. The method of claim 12 in which the slow positioner includes an X-axis translation stage and a Y-axis translation stage and in which the fast positioner is mounted on the X-axis translation stage.

- 30 15. The method of claim 14 further including the step of mounting the workpiece on the Y-axis translation stage.

16. The method of claim 12 in which the processing step comprises subtracting the delayed slow positioning signal from the delayed slow positioning

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commands to generate the fast positioning signal.

17. The method of claim 12 in which the filtering and delaying steps employ substantially a same amount of delay.

5

18. The method of claim 12 in which the applying step further includes:

sensing an actual position of at least one of the slow and fast positioners;

10 calculating a positional difference between the actual position and a commanded position; and

correcting a next commanded position by an amount corresponding to the positional difference.



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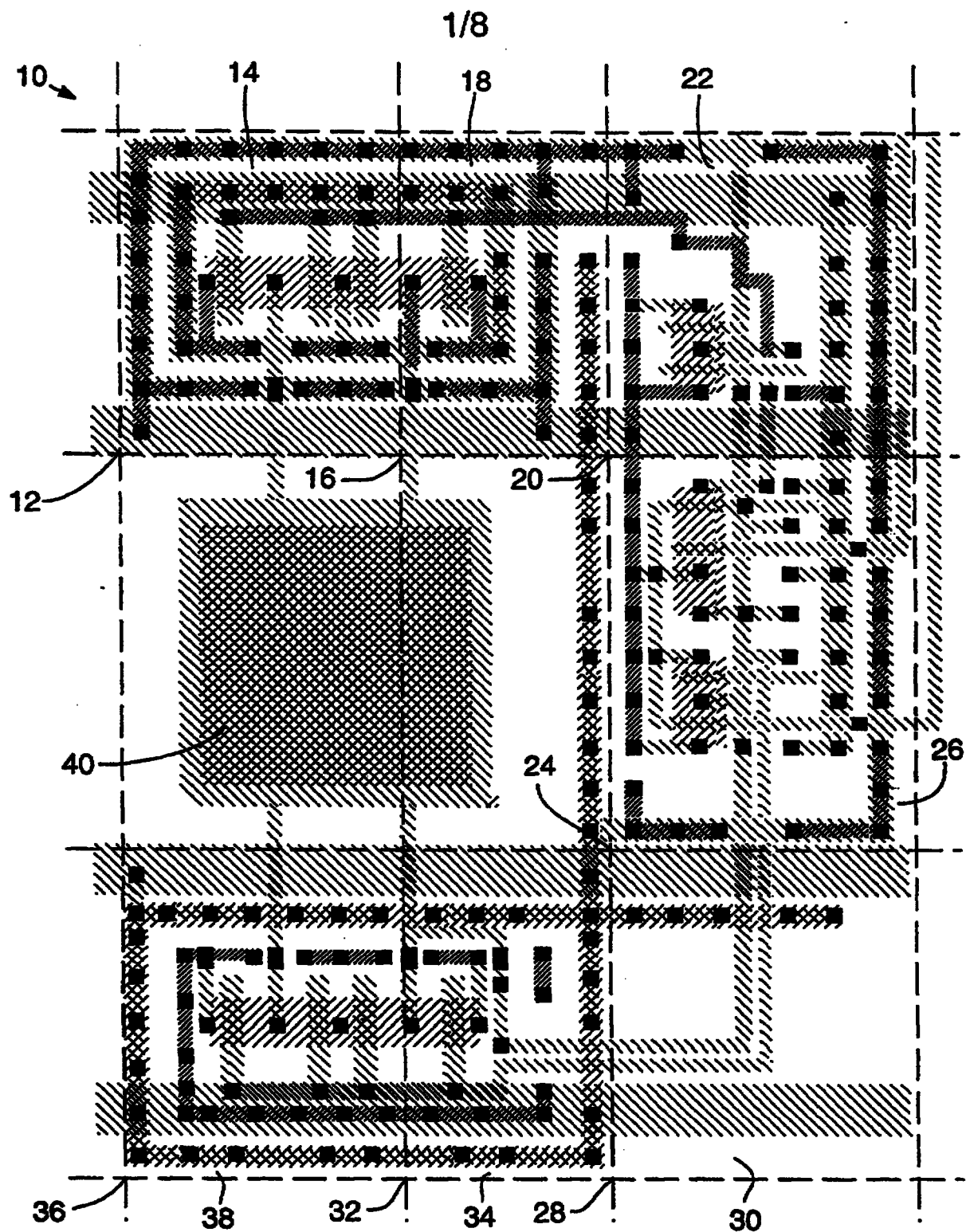
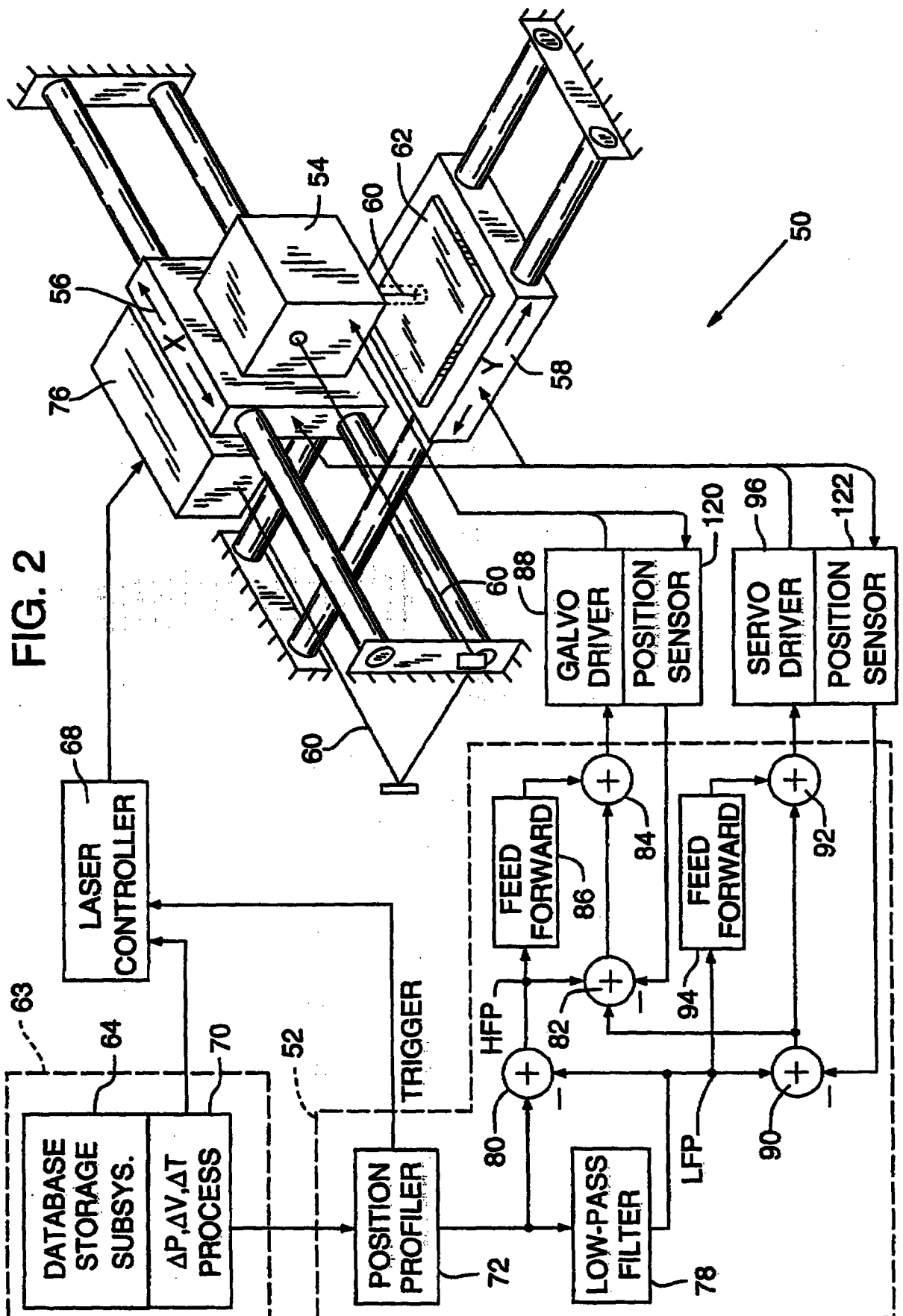
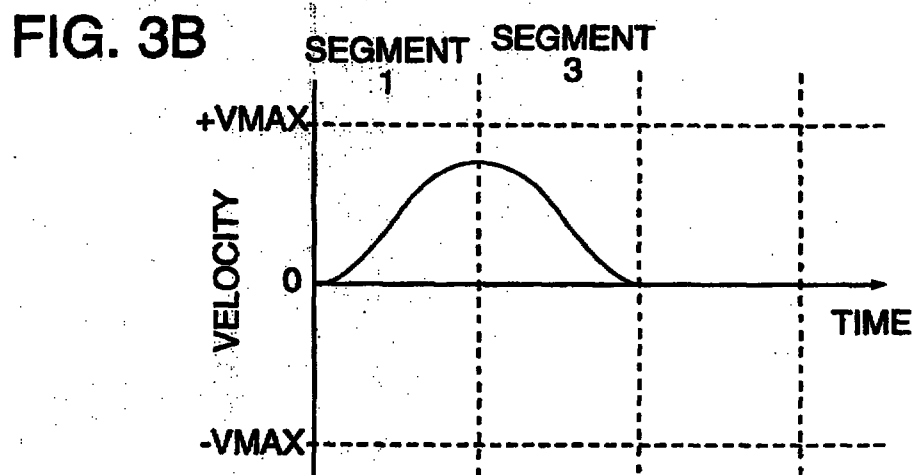
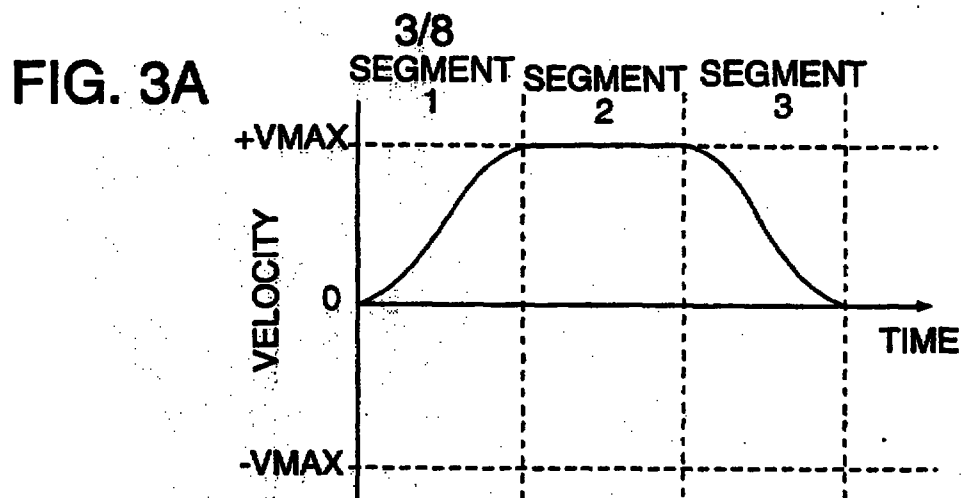


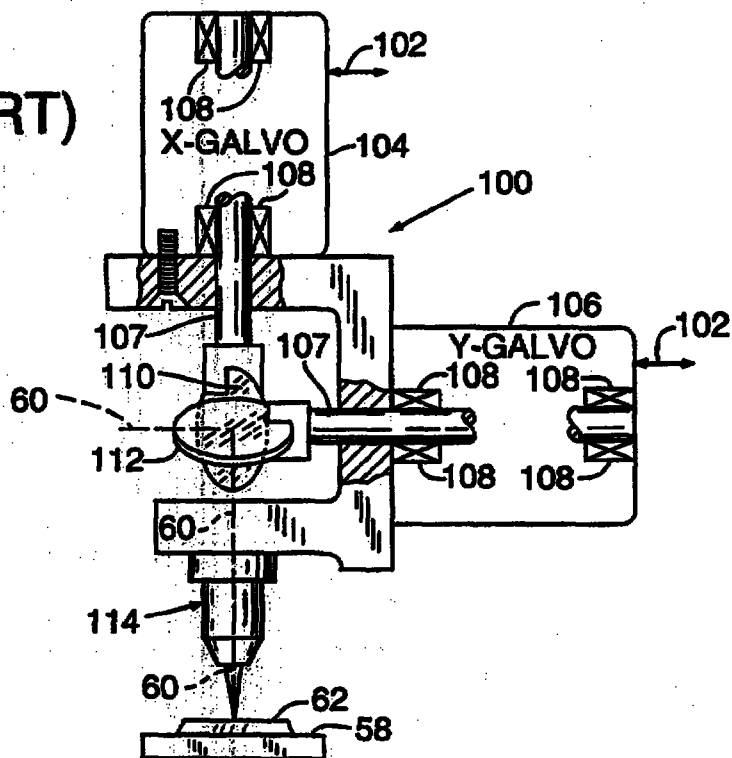
FIG. 1 (Prior Art)

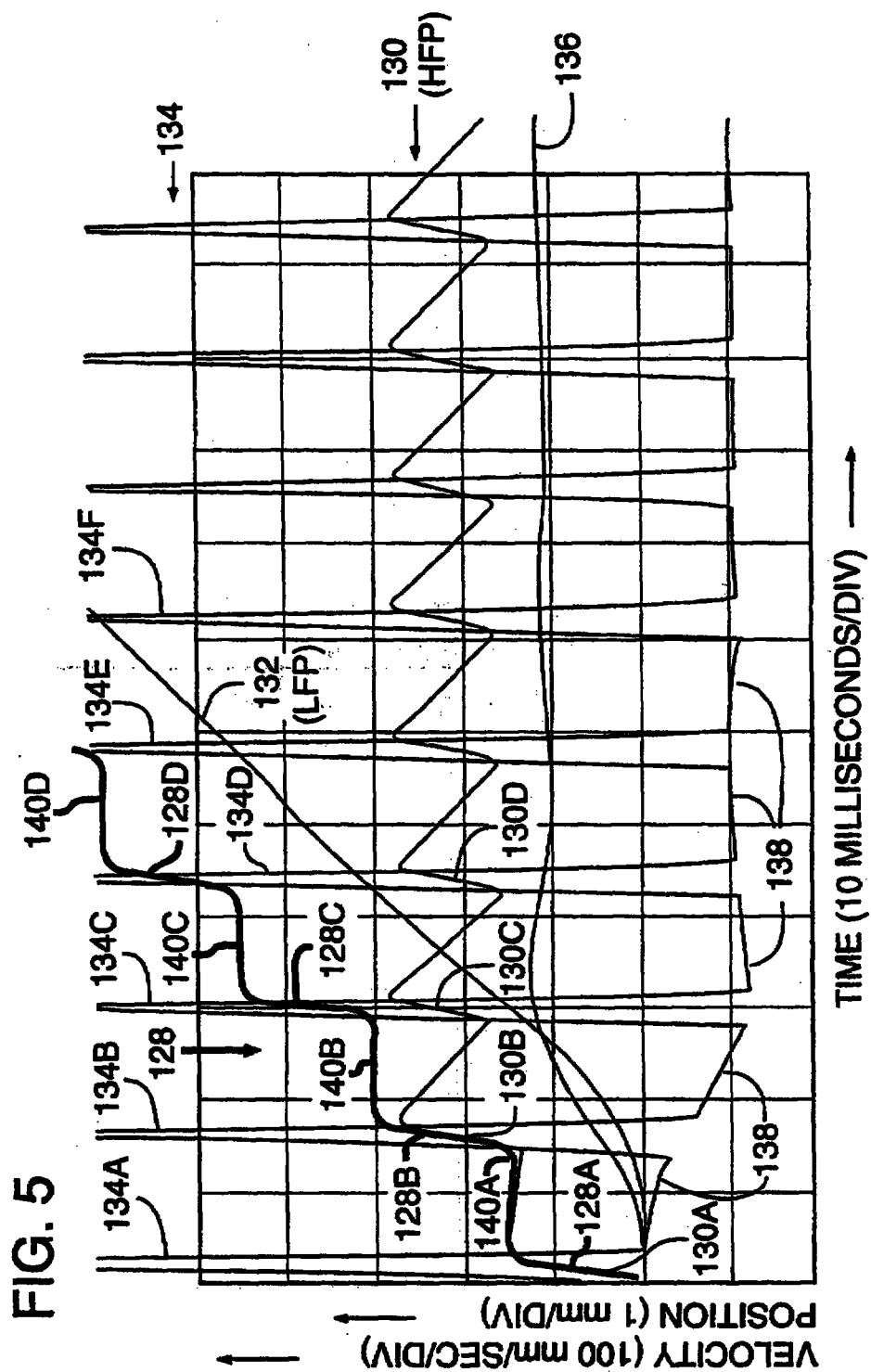
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**FIG. 4
(PRIOR ART)**





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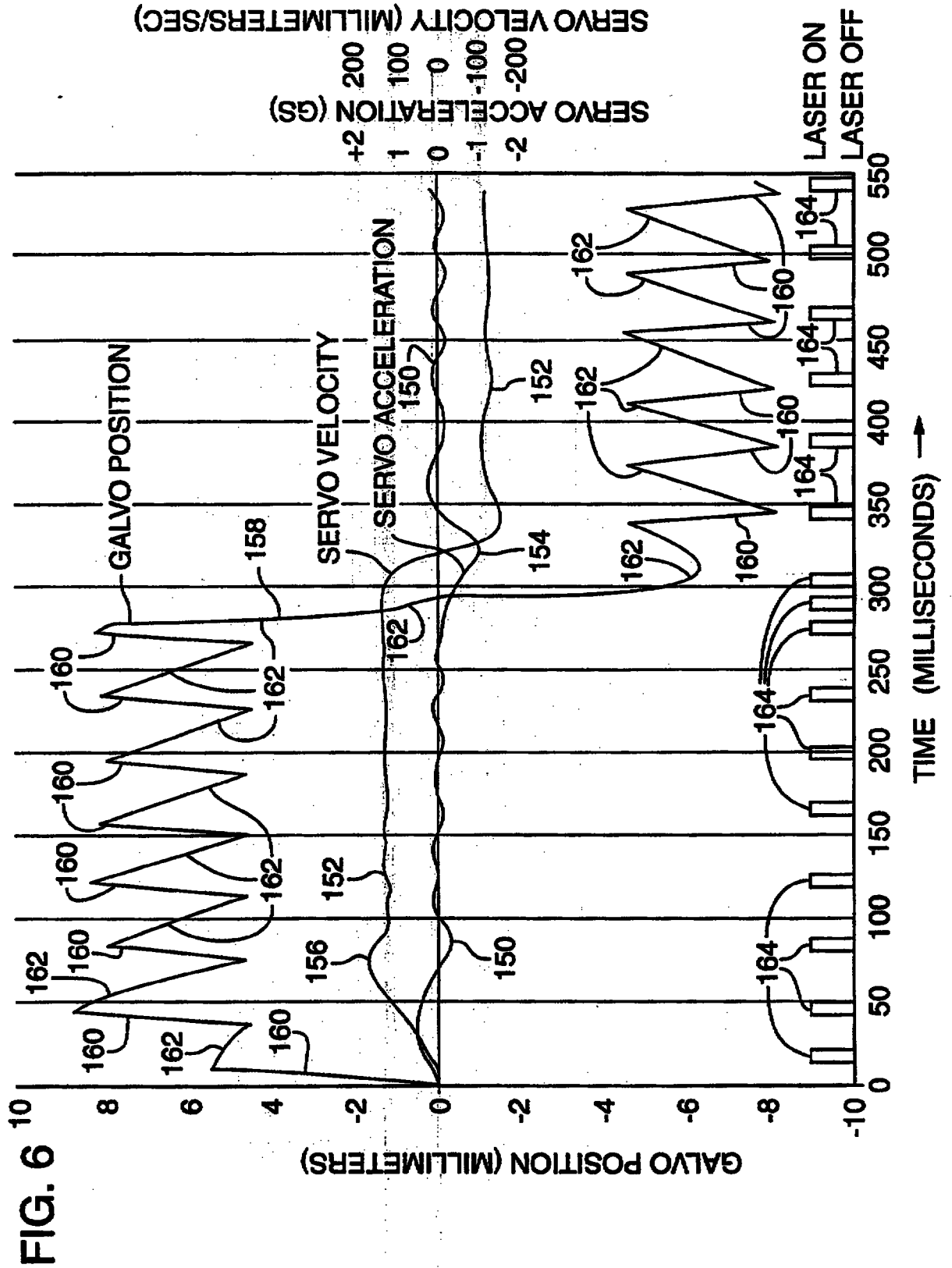
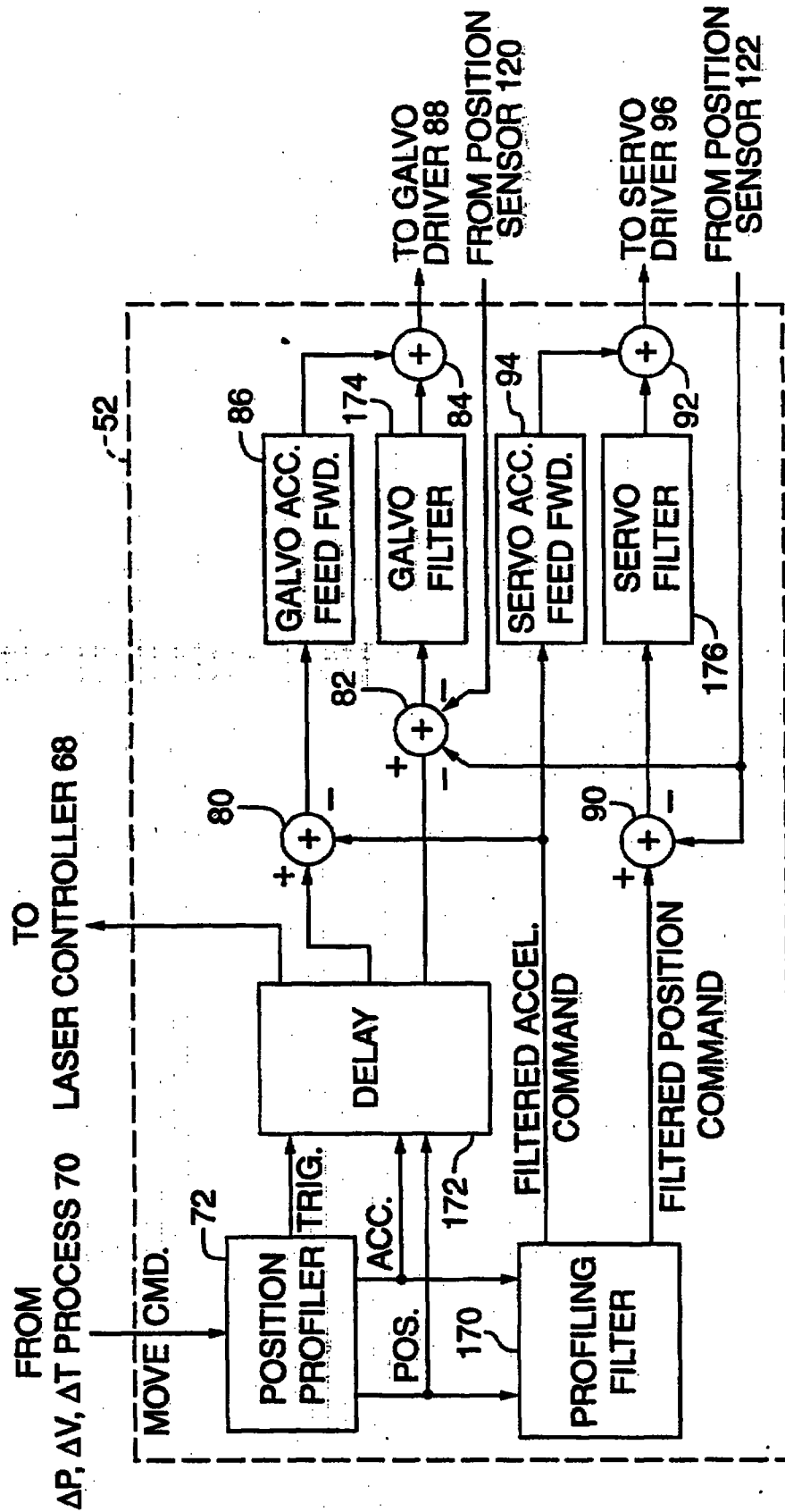
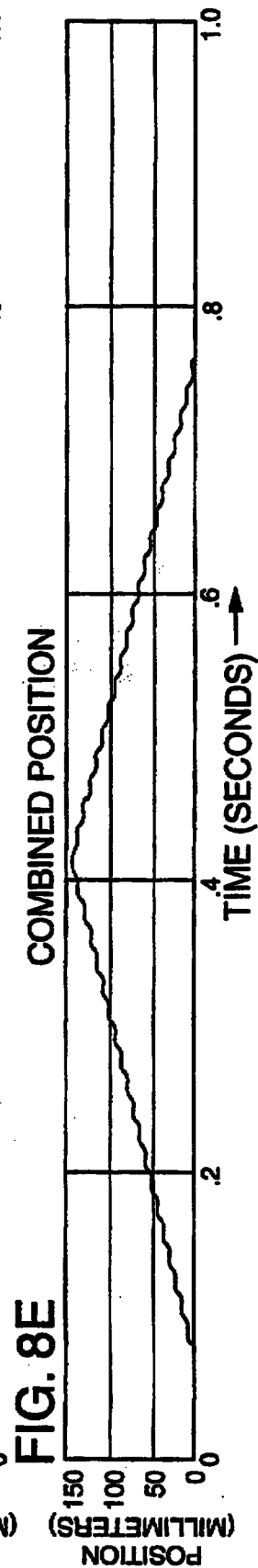
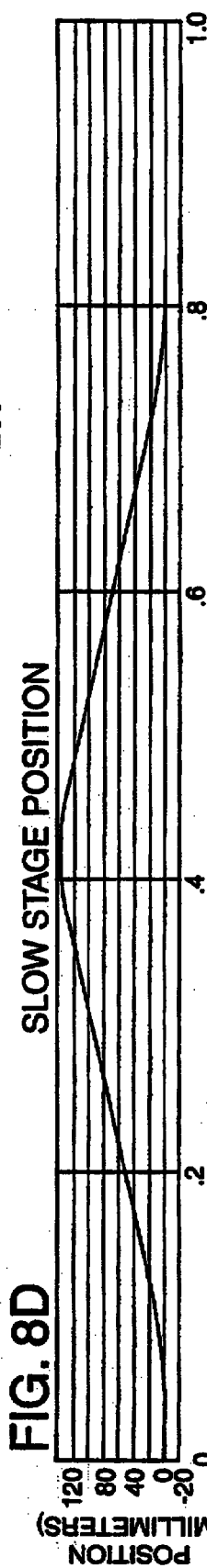
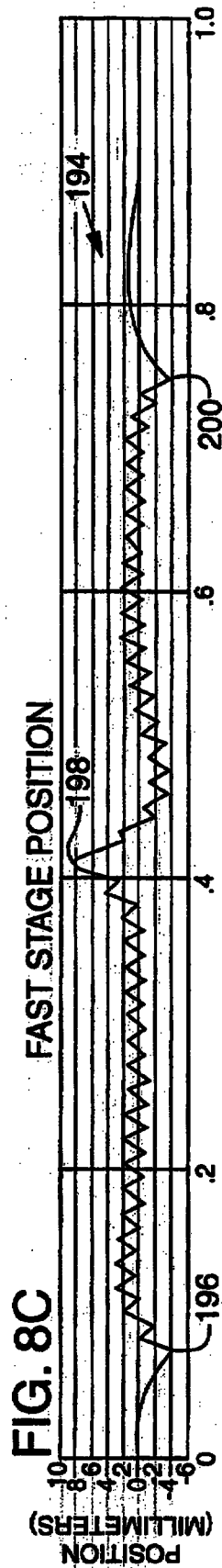
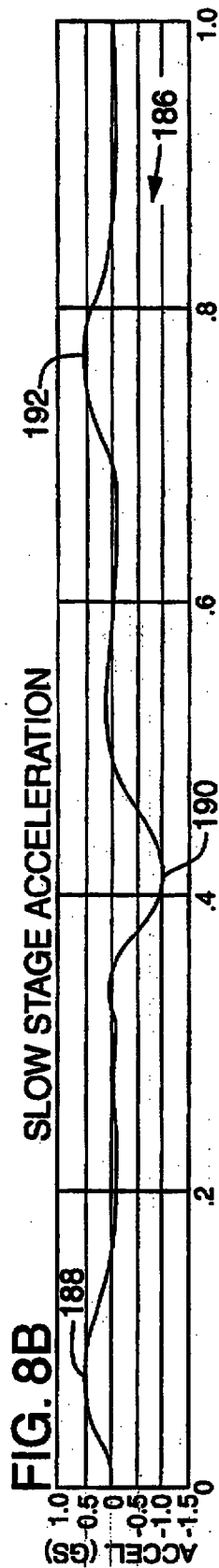
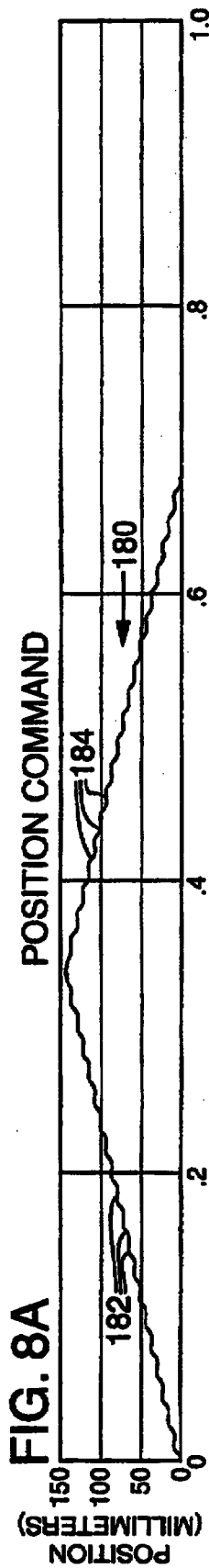


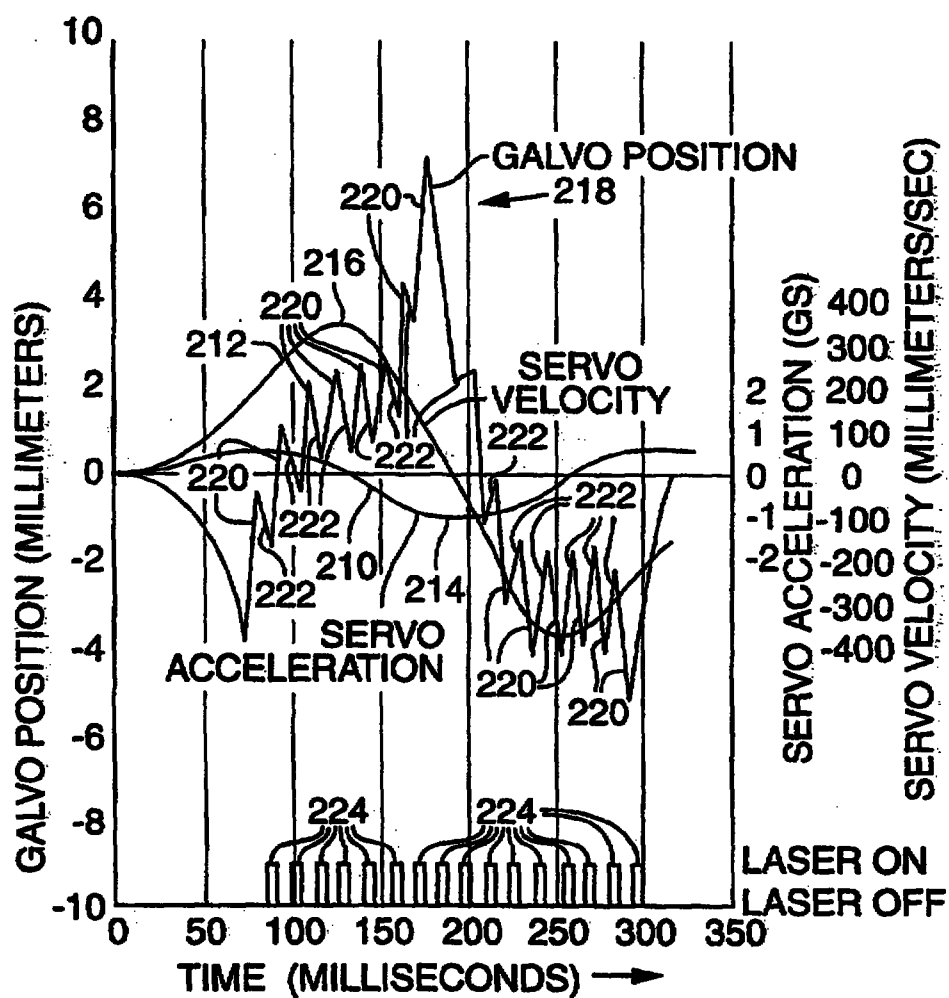
FIG. 7





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FIG. 9



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Claims

1. An apparatus (50) for positioning a tool (60) relative to a set of target locations on a workpiece (62) in response to a set of positioning commands (72):
- 5 comprising:
- a first positioner stage (54) effecting at a first positioning acceleration a controlled first range of relative movement (130, 158, 194) between the tool and the workpiece;
- 10 a second positioner stage (56, 58) effecting at a second positioning acceleration a controlled second range of relative movement (132) between the tool and the workpiece, the second range of relative movement being greater than the first range of relative movement, and the
- 15 second positioning acceleration being less than the first positioning acceleration;
- a signal processor (52) deriving from the set of positioning commands a movement-controlling signal (134, 138);
- 20 a filter (78, 170) splitting the movement-controlling signal into first (130) and second (132) frequency portions;
- a first positioner driver (88) controlling the first range of relative movement of the first positioner stage in response to the first frequency portion; and
- 25 a second positioner driver (96) controlling the second range of relative movement of the second positioner stage in response to the second frequency portion.
2. The apparatus of claim 1 in which the
- 30 positioning commands are unpanelized positioning commands.
3. The apparatus of claim 1 in which the filter (170) has an amount of delay that causes the second frequency portion to lag the first frequency portion by the amount of delay, and the apparatus further includes a
- 35 delay element (172) that delays the first frequency

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portion by substantially the amount of delay to provide a delayed first frequency portion that is substantially synchronized to the second frequency portion.

4. The apparatus of claim 1 in which the tool
5 is at least one of a drill, a punch, a laser (76), a laser beam (60), an ion beam, a radiation beam, a microscope, a lens, an optical scanner, and a camera.

5. The apparatus of claim 1 in which each of
the first and second positioner stages is moved by at
10 least one of a galvanometer (100), a voice coil, a piezoelectric transducer, a stepper motor, a rotary servo motor, a linear servo motor, and a lead screw.

6. The apparatus of claim 1 in which at least
one of the first and second positioner stages is capable
15 of positioning the tool along two orthogonal axes.

7. The apparatus of claim 1 in which the second
positioner stage includes an X-axis translation stage (56)
and a Y-axis translation stage (58) and the first
positioner stage (54) is mounted on the X-axis translation
20 stage.

8. The apparatus of claim 7 in which the
workpiece (62) is mounted on the Y-axis translation stage
(58).

9. The apparatus of claim 1 in which the first
25 and second positioner stages coordinate (130, 162, 222) the first and second positioning movements such that the tool is rendered temporarily stationary (140) relative to the workpiece while the first and second positioner stages are moving.

30 10. The apparatus of claim 3 in which the delay element (172) is implemented as a programmed delay that is executed by the signal processor (52).

11. The apparatus of claim 1 in which the
filter (170) employs a fourth-order low-pass filtering

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function to generate a position component (132) of the second frequency portion.

12. The apparatus of claim 1 further including a fourth-order low-pass filter function (170) to generate from an acceleration component of the first frequency portion an acceleration component of the second frequency portion.

13. The apparatus of claim 1 in which the second frequency portion is subtracted (80) from the first frequency portion to generate a high-frequency positioning signal portion that drives the first positioner driver.

14. A method for positioning a tool (60) relative to a set of target locations on a workpiece (62), comprising the steps of:

15 providing positioning commands (134, 138) that define the set of target locations to which a tool is to be directed;

filtering (78, 170) the positioning commands to generate a slow positioning signal (132);

20 subtracting (80) the slow positioning signal from the positioning commands to generate a fast positioning signal (130); and

applying the slow and fast positioning signals to respective slow (56, 58) and fast (54) positioners, the slow and fast positioners responding to the positioning signals by at least partly uninterrupted concurrent motion in a coordinated fashion (130, 132) to produce temporarily stationary tool positions (140) over the target locations.

15. The method of claim 14 in which the positioning commands are unpanelized positioning commands.

16. The method of claim 14 further in which the filtering step (170) introduces a delay such that the slow positioning signal is a delayed slow positioning signal and the method further includes delaying (172) the positioning commands to generate delayed positioning



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commands that are time synchronized to the delayed slow positioning signal.

17. The method of claim 16 in which the subtracting step entails subtracting (80) the delayed slow positioning signal from the delayed slow positioning commands to generate a fast positioning signal, and the applying step entails applying the delayed slow and fast positioning signals to respective slow (56, 58) and fast (54) positioners, the slow and fast positioners responding to the positioning signals by at least partly uninterrupted concurrent motion in a coordinated fashion (130, 132) to produce temporarily stationary tool positions (140) over the target locations.

18. The method of claim 14 in which the applying step further entails moving the tool along a pair of orthogonal axes.

19. The method of claim 14 in which the slow positioner includes an X-axis translation stage (56) and a Y-axis translation stage (58) and in which the fast positioner (54) is mounted on the X-axis translation stage.

20. The method of claim 19 further including the step of mounting the workpiece (62) on the Y-axis translation stage (58).

21. The method of claim 14 in which the applying step further includes:

sensing (120, 122) an actual position of at least one of the slow and fast positioners;

calculating a positional difference (82, 90) between the actual position and a commanded position; and correcting a next commanded position (84, 86, 92, 94) by an amount corresponding to the positional difference.

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22. An apparatus (50) for positioning a tool (60) along a first axis (X) relative to a set of target locations on a workpiece (62), comprising:

a database storage system (64) providing from a database positioning commands (134, 138) that include the set of target locations to which a tool is to be directed;

a signal processor (52) deriving from the positioning commands slow (132) and fast (130) first axial direction positioning signals; and

slow and fast positioner drivers (96, 88) applying the slow and fast first axial direction positioning signals to respective slow and fast positioners (56, 54)), the slow and fast positioners responding to the respective slow and fast first axial direction positioning signals by at least partly uninterrupted concurrent movement (130, 132) in a coordinated fashion to produce temporarily stationary tool positions (140) over the target locations.

23. The apparatus of claim 22 in which the slow (56, 58) and fast (54) positioners further move the tool along a second axis (Y) that is orthogonal to the first axis (X).

24. The apparatus of claim 22 in which the slow positioner (56, 58) includes an X-axis translation stage (56) and a Y-axis translation stage (58) and in which the fast positioner (54) is mounted on the X-axis translation stage (56).

25. The apparatus of claim 24 in which the workpiece (62) is mounted on the Y-axis translation stage (58).

26. The apparatus of claim 22 in which the signal processor (52) further includes a profiler (72) that profiles the positioning commands into a substantially wide-frequency bandwidth series of half-sine positioning segments (134, 138).



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27. The apparatus of claim 26 in which the signal processor (52) further includes a filter (78, 170) that separates the series of half-sine positioning segments (134, 138) into lower (132) and higher (130) first axis frequency portions, the slow first axial direction positioning signal (132) being derived from the lower first axis frequency portion (138).

28. The apparatus of claim 27 in which the signal processor (52) generates the first axial direction fast positioning signal (130) by subtracting (80) the lower first axis frequency portion (138) from the series of half-sine positioning segments (134, 138).

29. The apparatus of claim 28 in which the filter (78, 170) passes a first axial direction feedthrough signal portion into the slow first axial direction positioning signal (132), and the signal processor (52) corrects the fast first axial direction positioning signal by adding (82, 90) the first axial direction feedthrough signal portion to the fast first axial direction positioning signal (130).

30. The apparatus of claim 22 in which the database storage system (64) provides successive first and second positioning commands, in which at least one of the slow (56, 58) and fast (54) positioners further includes a position sensor (120, 122) that provides an actual position datum, and in which the signal processor (52) receives the actual position datum, calculates (82, 90) a positional difference between the actual position datum and a position corresponding to the first positioning command, and corrects the second positioning command (84, 86, 92, 94) by an amount corresponding to the positional difference.

31. The apparatus of claim 22 in which the positioning commands are unpanelized positioning commands.

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32. Apparatus (50) for positioning a tool (60) relative to multiple target locations in succession on a workpiece (62) in response to a set of positioning commands (134, 138), comprising:

5 a first positioner stage (54) effecting at a first positioning acceleration a controlled first range of relative movement (130, 158, 218) between the tool (60) and the workpiece (62);

10 a second positioner stage (56, 58) effecting at a second positioning acceleration (150, 210) a controlled second range of relative movement (132) between the tool and the workpiece; and

15 a signal processor (52) operatively associated with the first and second positioner stages and deriving from positioning commands in the set (134, 138) a positioner stage movement control signal including multiple signal frequency components, the signal processor performing a filtering function (78, 170) to produce from the signal frequency components of the movement control
20 signal first (130) and second (132) drive signals having respective different first and second frequency ranges, the first frequency range having a cutoff frequency and a bandwidth to which the first positioner stage (54) responds to operate at the first positioning acceleration
25 and the second frequency range having a cutoff frequency and a bandwidth to which the second positioner stage responds at the second positioning acceleration, the first and second drive signals causing at least partly
30 uninterrupted concurrent movement (140) of the first and second positioner stages such that the first positioning acceleration is greater than the second positioning acceleration and the first controlled range of relative movement is less than the second controlled range of relative movement, thereby reducing inertia-caused tool
35 positioning speed reduction resulting from interrupted

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positioner stage movement during positioning of the tool relative to successive target locations.

33. The apparatus of claim 32 in which the tool (60) is at least one of a drill, a punch, a laser (76), a laser beam (60), an ion beam, a radiation beam, a microscope, a lens, an optical scanner, and a camera.

34. The apparatus of claim 32 in which each of the first (54) and second (56, 58) positioner stages is moved by at least one of a galvanometer (100), a voice coil, a piezoelectric transducer, a stepper motor, a rotary servo motor, a linear servo motor, and a lead screw.

35. The apparatus of claim 32 in which the first and second ranges of relative movement are along an X-axis and at least one of the first and second positioner stages is further capable of positioning the tool along a Y-axis that is orthogonal to the X-axis.

36. The apparatus of claim 32 in which the second positioner stage includes an X-axis translation stage (56) and a Y-axis direct translation stage (58) and the first positioner stage (54) is mounted on the X-axis translation stage.

37. The apparatus of claim 36 in which the workpiece (62) is mounted on the Y-axis translation stage (58).

38. The apparatus of claim 32 in which the signal processor (52) further includes a position profiler (72) that generates the movement control signal, and the movement control signal includes a series of half-sine positioning pulses (134, 138) having a frequency range substantially spanning the first and second frequency ranges.

39. The apparatus of claim 38 in which the filtering function performed by the signal processor (52) is carried out by a low-pass filter (78, 170) that



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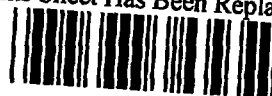
receives the series of half-sine positioning pulses (134, 138) and passes the second frequency range portion thereof (138) to produce the second drive signal.

5 40. The apparatus of claim 39 in which the signal processor (52) further performs a subtracting function in which the second drive signal (138) is subtracted (80) from the series of half-sine positioning pulses (134, 138) to produce the first drive signal (134).

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Claims

REPLACEMENT SHEETS		SG
☐ Description	: paged to paged	
☒ Claim(s)	: paged 30 to paged 36	
☐ Drawing(s)	: paged to paged	
☐ Abstract	: paged to paged	
DATE OF RECEIPT		19 SEP 1997

1. An apparatus (50) for positioning a tool
(60) relative to a set of target locations on a workpiece
(62) in response to a set of positioning commands (72),
5 the apparatus including a first positioner stage (54)
effecting at a first positioning acceleration a controlled
first range of relative movement (130, 158, 194) between
the tool and the workpiece and a second positioner stage
(56, 58) effecting at a second positioning acceleration a
10 controlled second range of relative movement (132) between
the tool and the workpiece, the second range of relative
movement being greater than the first range of relative
movement, and the second positioning acceleration being
less than the first positioning acceleration,
15 characterized by:
a signal processor (52) deriving from the set of
positioning commands a movement-controlling signal (134,
138);
a filter (78, 170) splitting the movement-
20 controlling signal into first (130) and second (132)
frequency portions;
a first positioner driver (88) controlling the
first range of relative movement of the first positioner
stage in response to the first frequency portion; and
25 a second positioner driver (96) controlling the
second range of relative movement of the second positioner
stage in response to the second frequency portion.
2. The apparatus of claim 1 in which the
positioning commands are unpanelized positioning commands.
3. The apparatus of claim 1 in which the filter
30 (170) has an amount of delay that causes the second
frequency portion to lag the first frequency portion by
the amount of delay, and the apparatus further includes a
delay element (172) that delays the first frequency
35 portion by substantially the amount of delay to provide a



delayed first frequency portion that is substantially synchronized to the second frequency portion.

4. The apparatus of claim 1 in which the tool is at least one of a drill, a punch, a laser (76), a laser beam (60), an ion beam, a radiation beam, a microscope, a lens, an optical scanner, and a camera.

5. The apparatus of claim 1 in which the second positioner stage includes an X-axis translation stage (56) and a Y-axis translation stage (58) and the first positioner stage (54) is mounted on the X-axis translation stage.

6. The apparatus of claim 5 in which the workpiece (62) is mounted on the Y-axis translation stage (58).

7. The apparatus of claim 1 in which the first and second positioner stages coordinate (130, 162, 222) the first and second positioning movements such that the tool is rendered temporarily stationary (140) relative to the workpiece while the first and second positioner stages are moving.

8. The apparatus of claim 3 in which the delay element (172) is implemented as a programmed delay that is executed by the signal processor (52).

9. The apparatus of claim 1 in which the filter (170) employs a low-pass filtering function to generate the second frequency portion.

10. The apparatus of claim 1 in which the second frequency portion is subtracted (80) from the first frequency portion to generate a high-frequency positioning signal portion from which a drive signal is derived to drive the first positioner driver.

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11. In a tool positioning system (50) that is implemented as part of a workpiece (62) processing system in which the workpiece is an electronic device or an electronic device package, the tool positioning system
5 having an axis of motion (X, Y) and including a first positioner (54) that effects at a first positioning acceleration a controlled first range of relative movement between a tool (60) and the workpiece and a second positioner (56, 58) that effects at a second positioning
10 acceleration a controlled second range of relative movement between the tool and the workpiece, the second controlled range of relative movement being greater than the first controlled range of relative movement and the second positioning acceleration being less than the first
15 positioning acceleration, a method of coordinating the operation of the first and second positioners to minimize displacement imparted by the first positioner relative to that imparted by the second positioner within the respective first and second controlled ranges of relative
20 movement as the first and second positioners concurrently move and selectively position the tool relative to a set of target locations and describe a tool path on the workpiece, comprising:

providing positioning commands that define a
25 tool path along which a tool is to be directed at controlled accelerations;

generating from the positioning commands higher bandwidth and lower bandwidth positioning signals that have an inherent delay offset between them;

30 deriving from the higher bandwidth and lower bandwidth positioning signals respective first and second positioning signals including a compensation delay (172) to compensate for the inherent delay offset between the higher bandwidth and lower bandwidth positioning signals;
35 and

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deriving from the first and second positioning signals first and second drive signals and applying the first and second drive signals to the respective first and second positioners so that they respond by operating within their controlled ranges of relative movement with at least partly uninterrupted concurrent motion in a coordinated fashion to produce accurate tool positioning along the tool path at the controlled accelerations.

12. The method of claim 11 in which the positioning commands are in an unpanelized format.

13. The method of claim 11 in which the generating the higher bandwidth and lower bandwidth positioning signals includes filtering the positioning commands to generate the lower bandwidth positioning signal and the inherent delay offset.

14. The method of claim 13 in which the filtering to generate the lower bandwidth positioning signal is carried out by a low-pass filtering function (170).

15. The method of claim 11 in which the deriving the first and second drive signals includes imparting the compensation delay to the positioning commands to form the higher bandwidth positioning signal and processing the higher bandwidth and lower bandwidth positioning signals to produce the first and second positioning signals from which the first and second drive signals are derived.

16. The method of claim 15 in which the processing the higher bandwidth and lower bandwidth positioning signals includes subtracting (80) the lower bandwidth positioning signal from the higher bandwidth positioning signal to produce the first positioning signal.

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17. The method of claim 11 in which the compensation delay and the inherent delay offset are substantially the same.

18. The method of claim 11 in which the
5 applying the first and second drive signals includes:
sensing (120, 122) an actual position of one of
the first and second positioners;
calculating (82, 90) a positional difference
between the actual position and a commanded position
10 specified by a corresponding one of the positioning
commands; and

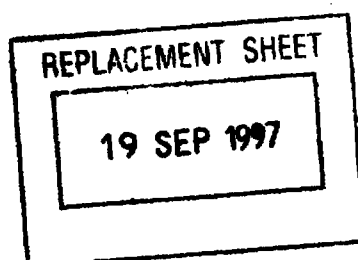
using the positional difference to develop one
of the first and second drive signals to correct an error
in the actual position of the one of the first and second
15 positioners to which the actual position pertains.

19. The method of claim 11 in which the
applying the first and second positioning signals
includes:

sensing (120, 122) first and second actual
20 positions of the first and second positioners;
calculating (82, 90) first and second positional
differences between a commanded position specified by a
corresponding one of the positioning commands and the
first and second actual positions; and

25 using the first and second positional
differences to develop the first and second drive signals
to correct errors in the first and second actual
positions.

20. The method of claim 11 in which the
30 applying the first and second positioning signals includes
operating the first and second positioners in the
coordinated fashion such that the tool is rendered
temporarily stationary relative to the workpiece while the
first and second positioners are moving.



21. The method of claim 11 in which the applying the first positioning signal includes:

sensing (120, 122) first and second actual positions of the first and second positioners;

5 calculating (82, 90) a first positional difference between a commanded position specified by a corresponding one of the positioning commands and the first and second actual positions; and

10 using the first positional difference to develop the first drive signal to correct at least in part errors in the first and second actual positions.

22. The method of claim 11 in which the second positioner includes an X-axis translation stage (56) and a Y-axis translation stage (58) and in which the first
15 positioner is mounted on the X-axis translation stage and the workpiece is mounted on the Y-axis translation stage.

23. The method of claim 11 in which the tool is at least one of a drill, a punch, a laser (76), a laser beam (60), an ion beam, a radiation beam, a microscope, a
20 lens, an optical scanner, and a camera.



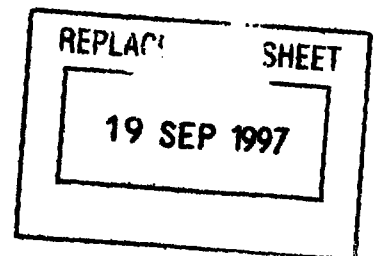
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MULTI-RATE POSITIONER SYSTEM
HAVING AN IMPROVED PROFILING FILTER

Abstract of the Disclosure

5 A multi-rate positioner system (50) receives
unpanelized positioning commands from a database storage
subsystem (64), profiles the commands (72) into a half-
sine positioning signal, and further processes the signal
10 into a low-frequency positioning signal (LFP) and a high-
frequency positioning signal (HFP) for actuating
respective slow (56, 58) and fast (54) positioners to
target locations on a workpiece (62). The slow and fast
positioners move without necessarily stopping in response
to a stream of positioning command data while coordinating
15 their individually moving positions to produce temporarily
stationary tool positions (140) over target locations
defined by the database. The multi-rate positioning
system reduces the fast positioner movement range
requirement while providing significantly increased tool
20 processing throughput.



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11. In a tool positioning system (50) that is implemented as part of a workpiece (62) processing system in which the workpiece is an electronic device or an electronic device package, the tool positioning system /
5 including a first positioner (54) that effects at a first positioning acceleration a controlled first range of relative movement between a tool (60) and the workpiece and a second positioner (56, 58) that effects at a second positioning acceleration a controlled second range of
10 relative movement between the tool and the workpiece, the second controlled range of relative movement being greater than the first controlled range of relative movement and the second positioning acceleration being less than the first positioning acceleration, a method of coordinating
15 the operation of the first and second positioners to minimize displacement imparted by the first positioner relative to that imparted by the second positioner within the respective first and second controlled ranges of relative movement as the first and second positioners
20 concurrently move and selectively position the tool relative to a set of target locations and describe a tool path on the workpiece, comprising:

providing positioning commands that define a tool path along which a tool is to be directed at
25 controlled accelerations;

generating from the positioning commands higher bandwidth and lower bandwidth positioning signals that have an inherent delay offset between them;

deriving from the higher bandwidth and lower bandwidth positioning signals respective first and second
30 positioning signals including a compensation delay (172) to compensate for the inherent delay offset between the higher bandwidth and lower bandwidth positioning signals; and

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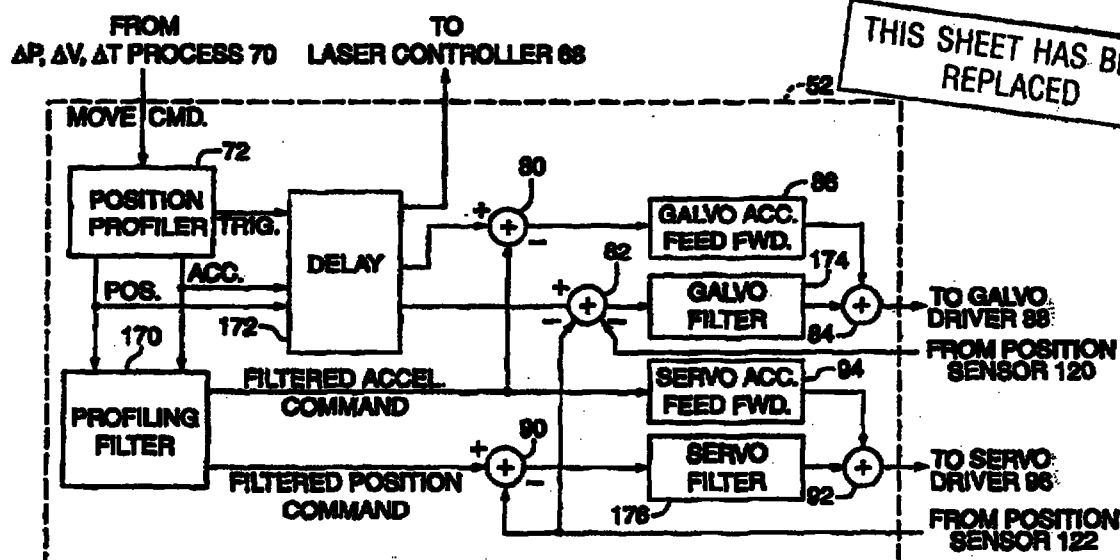
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(54) Title: MULTI-RATE POSITIONER SYSTEM HAVING AN IMPROVED PROFILING FILTER



(57) Abstract

A multi-rate positioner system (50) receives unpanelized positioning commands from a database storage subsystem (64), profiles the commands (72) into a half-sine positioning signal, and further processes the signal into a low-frequency positioning signal (LFP) and a high-frequency positioning signal (HFP) for actuating respective slow (56, 58) and fast (54) positioners to target locations on a workpiece (62). The slow and fast positioners move without necessarily stopping in response to a stream of positioning command-data while coordinating their individually moving positions to produce temporarily stationary tool positions (140) over target locations defined by the database. The multi-rate positioning system reduces the fast positioner movement range requirement while providing significantly increased tool processing throughput.